



**flowPACK 1 H6.5**

**650 V / 50 A**

**Features**

- Innovative H6.5 topology
- Fast IGBT
- Optimized for wide range of load conditions
- LVRT (Low voltage ride through) capability
- Low inductance package
- Integrated temperature sensor

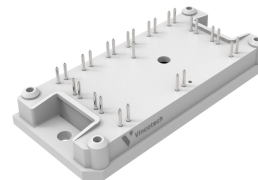
**Target applications**

- Solar Inverters
- Special Application

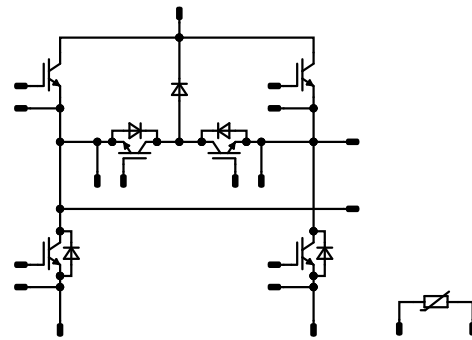
**Types**

- 10-FY07HVA050RG-L984F88

**flow 1 12 mm housing**



**Schematic**





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10-FY07HVA050RG-L984F88  
datasheet

## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
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### Buck Switch

Collector-emitter voltage	$V_{CES}$		650	V
Collector current (DC current)	$I_C$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	46	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	200	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	77	W
Gate-emitter voltage	$V_{GES}$		$\pm 30$	V
Maximum junction temperature	$T_{jmax}$		175	°C

### Buck Diode

Peak repetitive reverse voltage	$V_{RRM}$		650	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	30	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	120	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	53	W
Maximum junction temperature	$T_{jmax}$		175	°C

### Boost Switch

Collector-emitter voltage	$V_{CES}$		650	V
Collector current (DC current)	$I_C$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	46	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	200	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	77	W
Gate-emitter voltage	$V_{GES}$		$\pm 30$	V
Maximum junction temperature	$T_{jmax}$		175	°C

**Maximum Ratings** $T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>Boost Diode</b>				
Peak repetitive reverse voltage	$V_{RRM}$		650	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	30	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	120	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	53	W
Maximum junction temperature	$T_{jmax}$		175	°C

**Module Properties****Thermal Properties**

Storage temperature	$T_{stg}$		-40...+125	°C
Operation temperature under switching condition	$T_{jop}$		-40...+( $T_{jmax} - 25$ )	°C

**Isolation Properties**

Isolation voltage	$V_{isol}$	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
Isolation voltage	$V_{isol}$	AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			>12,7	mm
Clearance			7,85	mm
Comparative Tracking Index	CTI		≥ 200	

\*100 % tested in production



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### Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max		

#### Buck Switch

##### Static

Gate-emitter threshold voltage	$V_{GE(th)}$		5	0,033	25	5	6	7	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	15		50	25 125 150		1,5 1,66 1,7	1,9 <sup>(1)</sup>	V
Collector-emitter cut-off current	$I_{CES}$	0	650		25			0,01	mA
Gate-emitter leakage current	$I_{GES}$	30	0		25			0,2	µA
Internal gate resistance	$r_g$						None		Ω
Input capacitance	$C_{ies}$						4200		pF
Output capacitance	$C_{oes}$	$f = 1 \text{ Mhz}$	0	30	25		104		pF
Reverse transfer capacitance	$C_{res}$						79		pF
Gate charge	$Q_g$	15	400	50	25		141		nC

##### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)					1,23		K/W
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##### Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 8 \Omega$ $R_{goff} = 8 \Omega$	-5/15	350	40	25		40		ns				
						125		39						
						150		38						
Rise time	$t_r$									25		9		ns
										125		10		
										150		11		
Turn-off delay time	$t_{d(off)}$									25		111		ns
										125		123		
										150		127		
Fall time	$t_f$									25		29,84		ns
										125		62,35		
										150		72,9		
Turn-on energy (per pulse)	$E_{on}$	$Q_{tFWD} = 1,44 \mu\text{C}$ $Q_{tFWD} = 2,28 \mu\text{C}$ $Q_{tFWD} = 2,54 \mu\text{C}$				25		0,364		mWs				
						125		0,504						
						150		0,557						
Turn-off energy (per pulse)	$E_{off}$					25		0,542		mWs				
						125		0,684						
						150		0,804						



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### Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max		

#### Buck Diode

##### Static

Forward voltage	$V_F$				30	25 125 150		1,58 1,75 1,69	1,9 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_r = 650$ V				25			10	μA

##### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,8		K/W
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##### Dynamic

Peak recovery current	$I_{RRM}$	$di/dt=5655$ A/μs $di/dt=5116$ A/μs	-5/15	350	40	25		69,62		A
Reverse recovery time	$t_{rr}$					125		81,9		
						150		84,52		
						25		27,54		
Recovered charge	$Q_r$					125		53,77		
						150		57,04		
		25		1,44						
Reverse recovered energy	$E_{rec}$	125		2,28						
		150		2,54						
		25		0,452						
Peak rate of fall of recovery current	$(di_r/dt)_{max}$	125		0,683						
		150		0,753						
		25		7107						
		125		7107						
		150		6871						



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### Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GS}$ [V]	$V_{GE}$ [V]	$V_{DS}$ [V]	$V_{CE}$ [V]	$T_j$ [°C]	Min	Typ	Max	

#### Boost Switch

##### Static

Gate-emitter threshold voltage	$V_{GE(th)}$			5	0,033	25	5	6	7	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		50	25 125 150		1,5 1,66 1,7	1,9 <sup>(1)</sup>	V
Collector-emitter cut-off current	$I_{CES}$		0	650		25			0,01	mA
Gate-emitter leakage current	$I_{GES}$		30	0		25			0,2	μA
Internal gate resistance	$r_g$							None		Ω
Input capacitance	$C_{ies}$							4200		pF
Output capacitance	$C_{oes}$	$f = 1 \text{ Mhz}$	0	30		25		104		pF
Reverse transfer capacitance	$C_{res}$							79		pF
Gate charge	$Q_g$		15	400	50	25		141		nC

##### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,23		K/W
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##### Dynamic

Turn-on delay time	$t_{d(on)}$					25 125 150		48 48 39		ns
Rise time	$t_r$					25 125 150		10 10 10		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		112 126 129		ns
Fall time	$t_f$					25 125 150		23,69 43,85 69,76		ns
Turn-on energy (per pulse)	$E_{on}$	$Q_{tFWD} = 1,24 \mu\text{C}$ $Q_{tFWD} = 1,87 \mu\text{C}$ $Q_{tFWD} = 2,66 \mu\text{C}$				25 125 150		0,382 0,486 0,582		mWs
Turn-off energy (per pulse)	$E_{off}$					25 125 150		0,483 0,678 0,749		mWs



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datasheet

### Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max		
<b>Boost Diode</b>										
<b>Static</b>										
Forward voltage	$V_F$				30	25 125 150		1,58 1,75 1,69	1,9 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_T = 650$ V				25			10	μA
<b>Thermal</b>										
Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,8		K/W
<b>Dynamic</b>										
Peak recovery current	$I_{RRM}$					25 125 150		65,31 73,95 80,44		A
Reverse recovery time	$t_{rr}$					25 125 150		27,1 55,95 102,01		ns
Recovered charge	$Q_r$	$di/dt=5242$ A/μs $di/dt=5023$ A/μs $di/dt=4998$ A/μs	-5/15	350	40	25 125 150		1,24 1,87 2,66		μC
Reverse recovered energy	$E_{rec}$					25 125 150		0,462 0,683 0,772		mWs
Peak rate of fall of recovery current	$(di_r/dt)_{max}$					25 125 150		6528 6096 5695		A/μs



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### Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GS}$ [V]	$V_{GE}$ [V]	$V_{DS}$ [V]	$V_{CE}$ [V]	$T_j$ [°C]	Min	Typ	Max	

### Thermistor

#### Static

Rated resistance	$R$					25		22		kΩ
Deviation of $R_{100}$	$A_{R/R}$	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	$P$							5		mW
Power dissipation constant	$d$					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 1 \%$						3962		K
B-value	$B_{(25/100)}$	Tol. $\pm 1 \%$						4000		K
Vincotech Thermistor Reference									I	

<sup>(1)</sup> Value at chip level

<sup>(2)</sup> Only valid with pre-applied Vincotech thermal interface material.



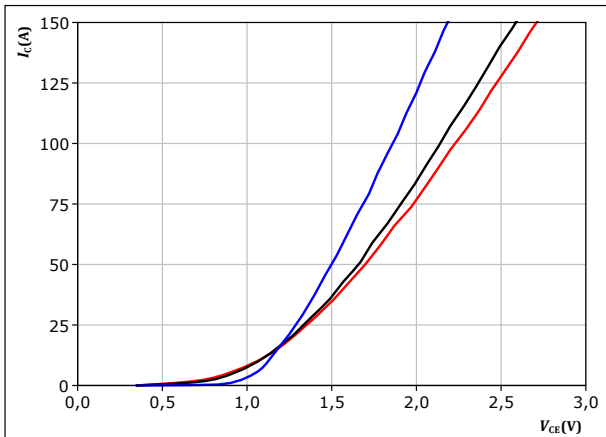


### Buck Switch Characteristics

**figure 1.** IGBT

Typical output characteristics

$I_C = f(V_{CE})$

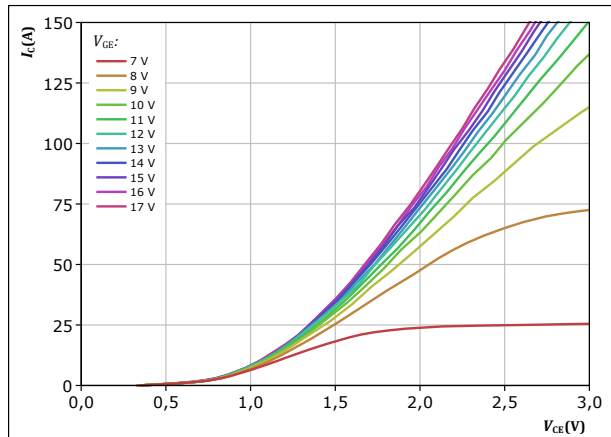


$t_p = 250 \mu s$   
 $V_{GE} = 15 V$   
 $T_j:$  25 °C, 125 °C, 150 °C

**figure 2.** IGBT

Typical output characteristics

$I_C = f(V_{CE})$

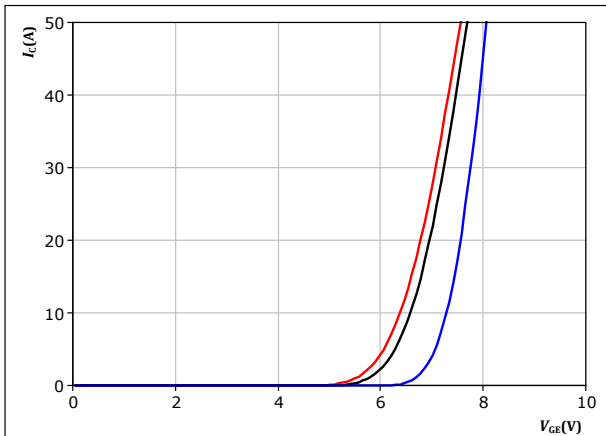


$t_p = 250 \mu s$   
 $T_j = 150 \text{ °C}$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**figure 3.** IGBT

Typical transfer characteristics

$I_C = f(V_{GE})$

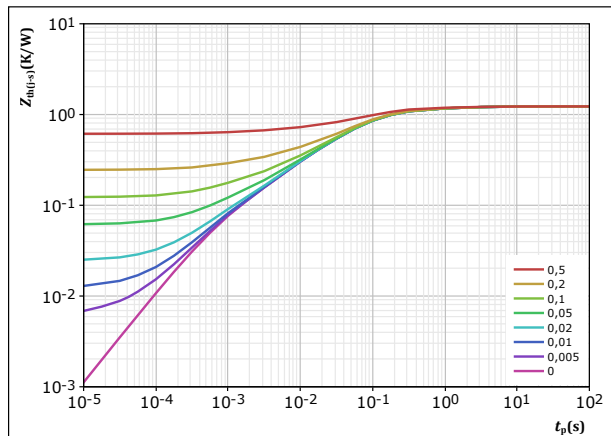


$t_p = 250 \mu s$   
 $V_{CE} = 10 V$   
 $T_j:$  25 °C, 125 °C, 150 °C

**figure 4.** IGBT

Transient thermal impedance as a function of pulse width

$Z_{th(j-s)} = f(t_p)$



$D = t_p / T$   
 $R_{th(j-s)} = 1,228 \text{ K/W}$   
IGBT thermal model values  

$R$ (K/W)	$\tau$ (s)
5,07E-02	3,25E+00
1,43E-01	5,26E-01
5,97E-01	9,03E-02
2,58E-01	2,71E-02
1,27E-01	5,65E-03
5,33E-02	7,25E-04

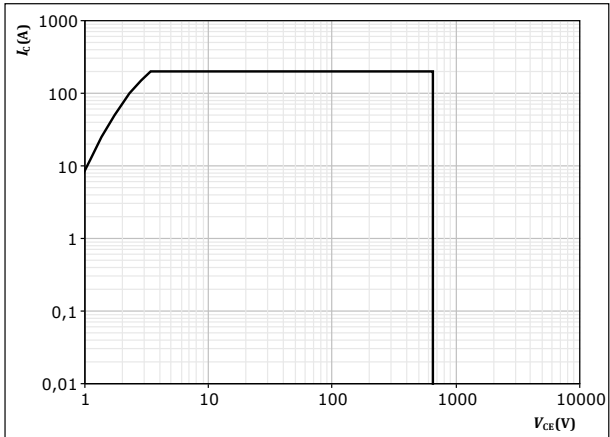


### Buck Switch Characteristics

figure 5. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



D = single pulse  
T<sub>s</sub> = 80 °C  
V<sub>CE</sub> = 15 V  
T<sub>j</sub> = T<sub>jmax</sub>



### Buck Diode Characteristics

figure 6. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

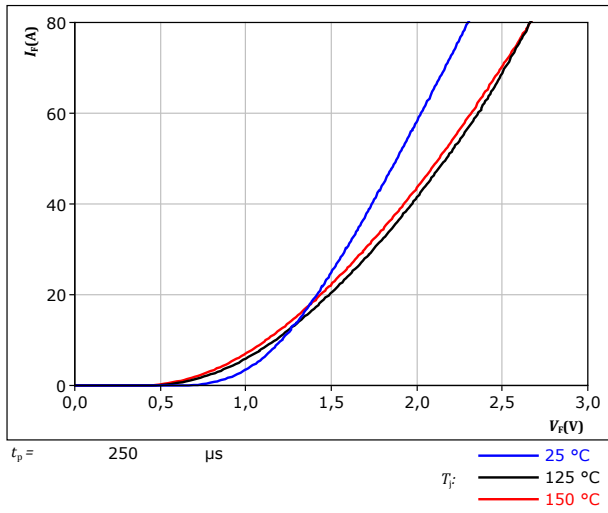
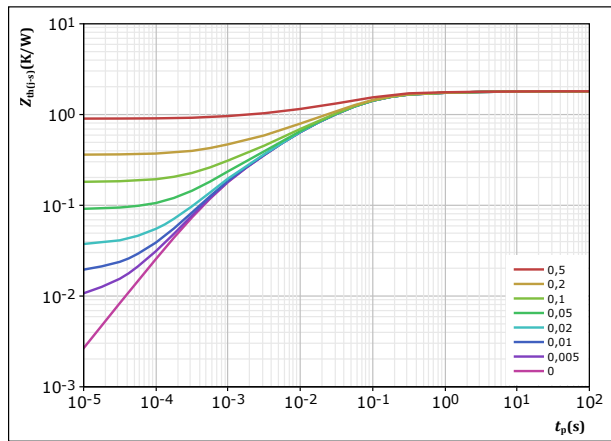


figure 7. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 1,803 \text{ K/W}$   
 FWD thermal model values

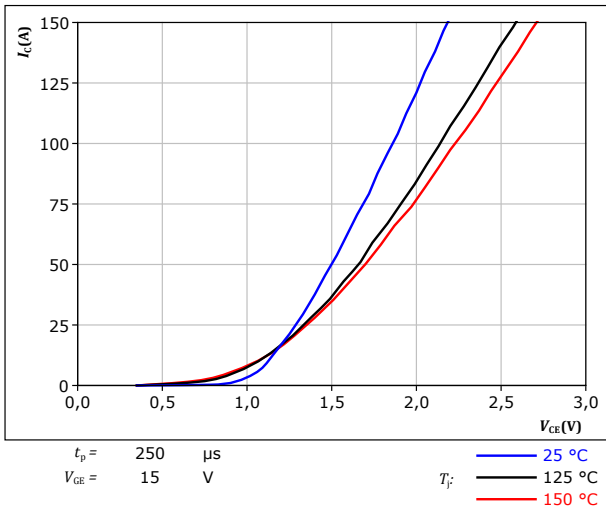
R (K/W)	$\tau$ (s)
5,16E-02	5,27E+00
1,29E-01	5,85E-01
6,80E-01	8,65E-02
4,86E-01	2,55E-02
3,20E-01	5,42E-03
1,36E-01	7,50E-04



### Boost Switch Characteristics

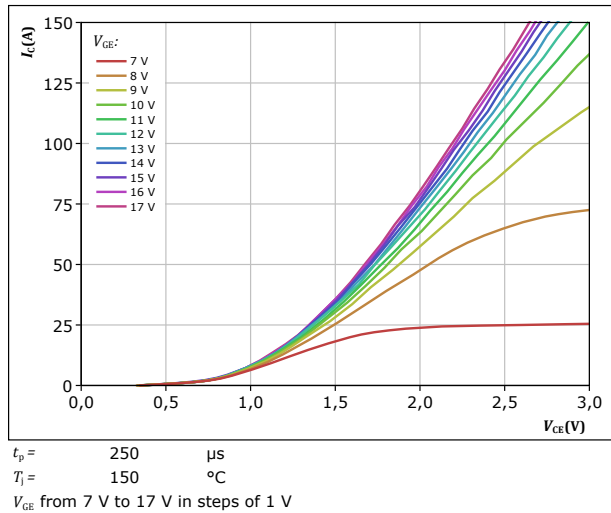
**figure 8.** IGBT

Typical output characteristics  
 $I_C = f(V_{CE})$



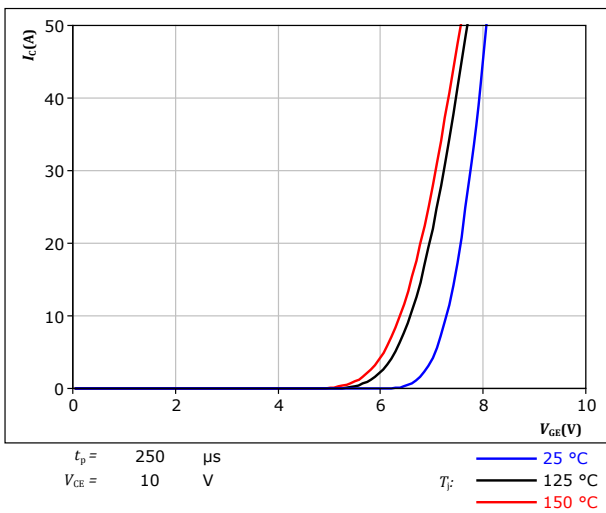
**figure 9.** IGBT

Typical output characteristics  
 $I_C = f(V_{CE})$



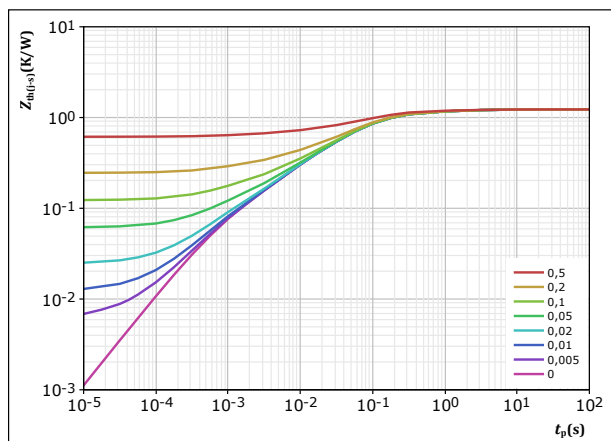
**figure 10.** IGBT

Typical transfer characteristics  
 $I_C = f(V_{GE})$



**figure 11.** IGBT

Transient thermal impedance as a function of pulse width  
 $Z_{th(j-s)} = f(t_p)$



IGBT thermal model values

R (K/W)	$\tau$ (s)
5,07E-02	3,25E+00
1,43E-01	5,26E-01
5,97E-01	9,03E-02
2,58E-01	2,71E-02
1,27E-01	5,65E-03
5,33E-02	7,25E-04

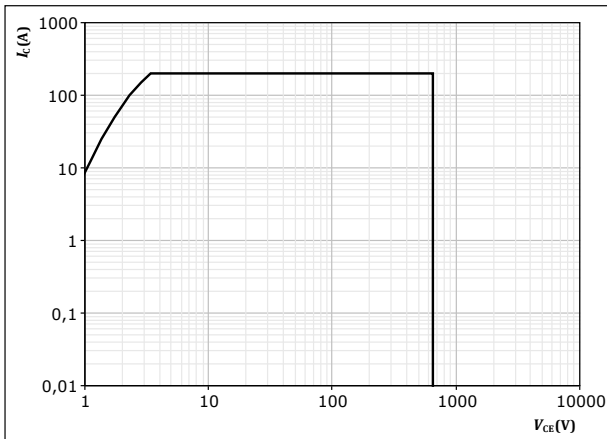


### Boost Switch Characteristics

figure 12. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



D = single pulse  
T<sub>s</sub> = 80 °C  
V<sub>CE</sub> = 15 V  
T<sub>j</sub> = T<sub>jmax</sub>



### Boost Diode Characteristics

figure 13. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

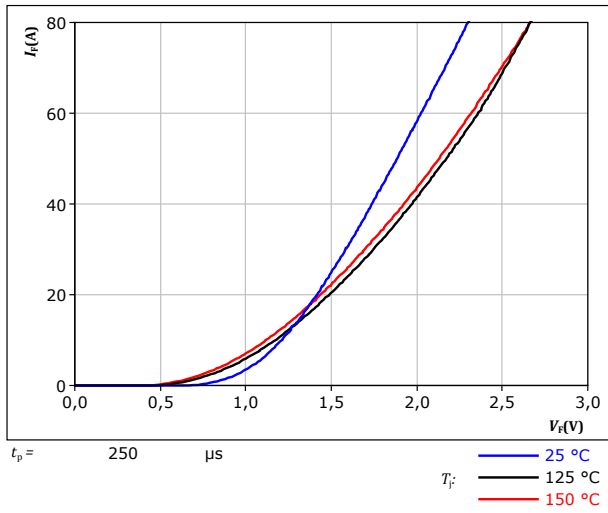
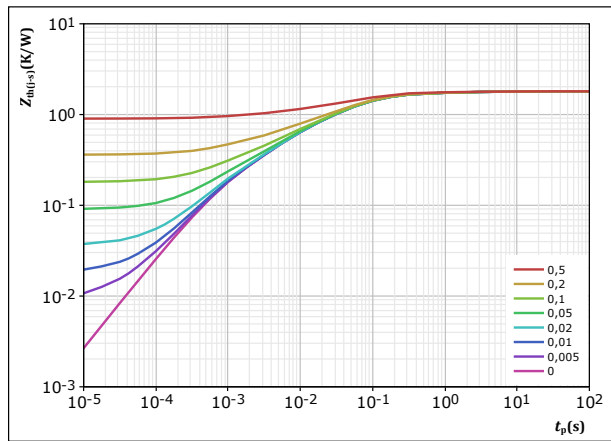


figure 14. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 1,803 \text{ K/W}$   
 FWD thermal model values

R (K/W)	$\tau$ (s)
5,16E-02	5,27E+00
1,29E-01	5,85E-01
6,80E-01	8,65E-02
4,86E-01	2,55E-02
3,20E-01	5,42E-03
1,36E-01	7,50E-04

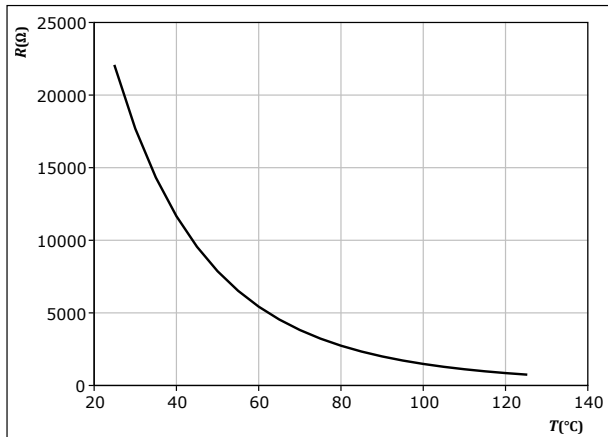


### Thermistor Characteristics

figure 15. Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$

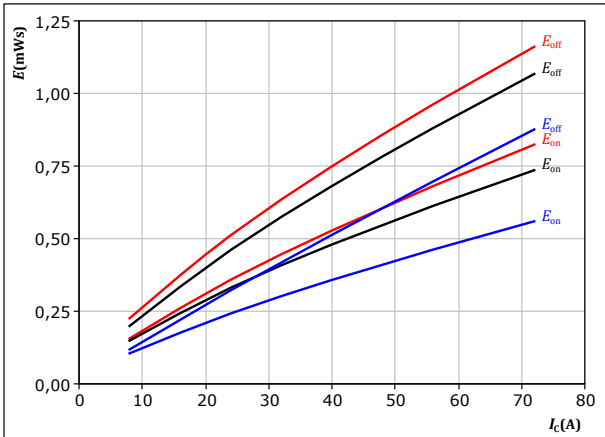




## Buck Switching Characteristics

**figure 16.** IGBT

Typical switching energy losses as a function of collector current  
 $E = f(I_c)$

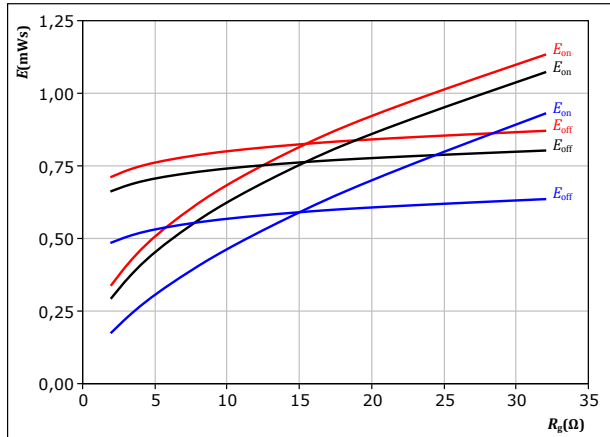


With an inductive load at

$V_{CE} = 350$ V	$T_j:$ 25 °C
$V_{GE} = -5/15$ V	125 °C
$R_{g(on)} = 8$ Ω	150 °C
$R_{g(off)} = 8$ Ω	

**figure 17.** IGBT

Typical switching energy losses as a function of gate resistor  
 $E = f(R_g)$

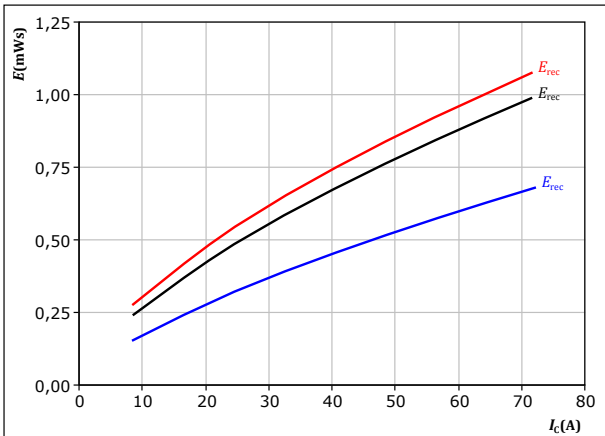


With an inductive load at

$V_{CE} = 350$ V	$T_j:$ 25 °C
$V_{GE} = -5/15$ V	125 °C
$I_c = 40$ A	150 °C

**figure 18.** FWD

Typical reverse recovered energy loss as a function of collector current  
 $E_{rec} = f(I_c)$

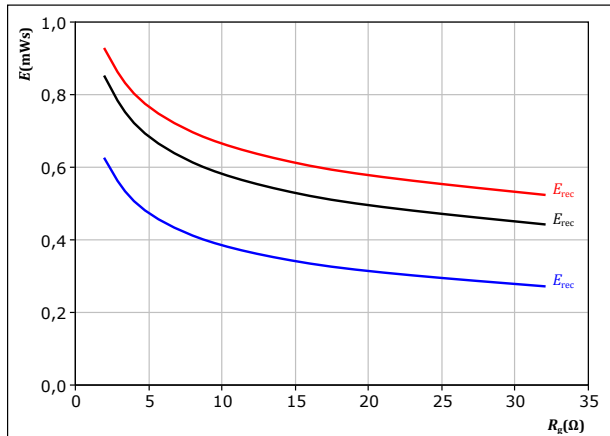


With an inductive load at

$V_{CE} = 350$ V	$T_j:$ 25 °C
$V_{GE} = -5/15$ V	125 °C
$R_{g(on)} = 8$ Ω	150 °C

**figure 19.** FWD

Typical reverse recovered energy loss as a function of gate resistor  
 $E_{rec} = f(R_g)$



With an inductive load at

$V_{CE} = 350$ V	$T_j:$ 25 °C
$V_{GE} = -5/15$ V	125 °C
$I_c = 40$ A	150 °C

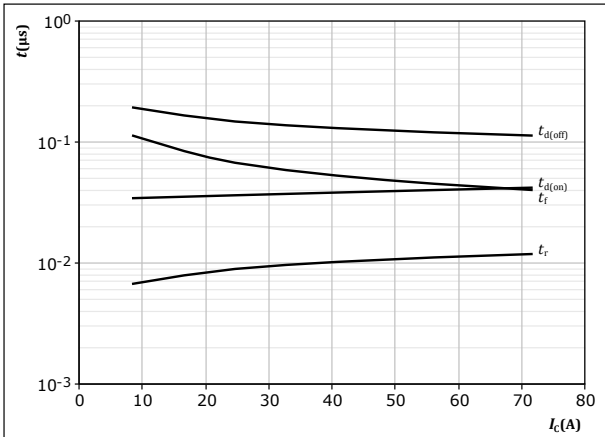




## Buck Switching Characteristics

**figure 20.** IGBT

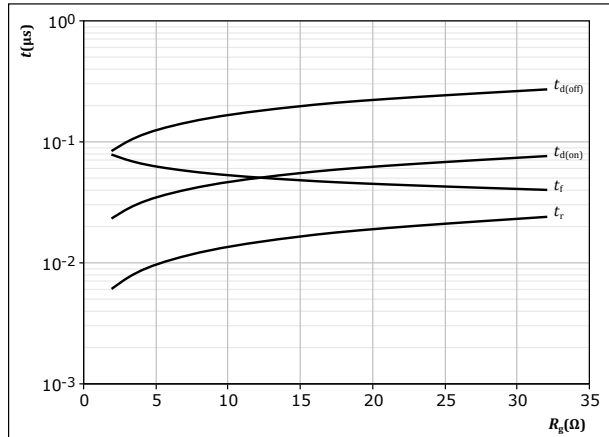
Typical switching times as a function of collector current  
 $t = f(I_c)$



With an inductive load at  
 $T_j = 150$  °C  
 $V_{CE} = 350$  V  
 $V_{GE} = -5/15$  V  
 $R_{g(on)} = 8$  Ω  
 $R_{g(off)} = 8$  Ω

**figure 21.** IGBT

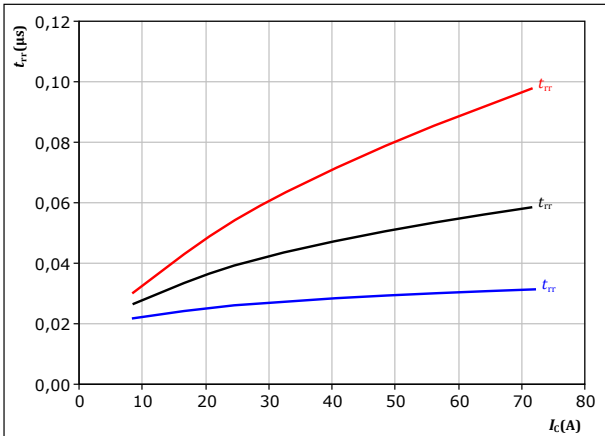
Typical switching times as a function of gate resistor  
 $t = f(R_g)$



With an inductive load at  
 $T_j = 150$  °C  
 $V_{CE} = 350$  V  
 $V_{GE} = -5/15$  V  
 $I_c = 40$  A

**figure 22.** FWD

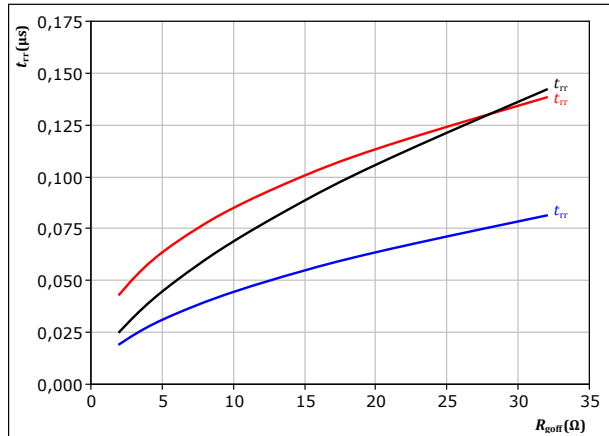
Typical reverse recovery time as a function of collector current  
 $t_{rr} = f(I_c)$



With an inductive load at  
 $V_{CE} = 350$  V  
 $V_{GE} = -5/15$  V  
 $R_{g(on)} = 8$  Ω  
 $T_j:$  — 25 °C  
— 125 °C  
— 150 °C

**figure 23.** FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor  
 $t_{rr} = f(R_{g(off)})$



With an inductive load at  
 $V_{CE} = 350$  V  
 $V_{GE} = -5/15$  V  
 $I_c = 40$  A  
 $T_j:$  — 25 °C  
— 125 °C  
— 150 °C

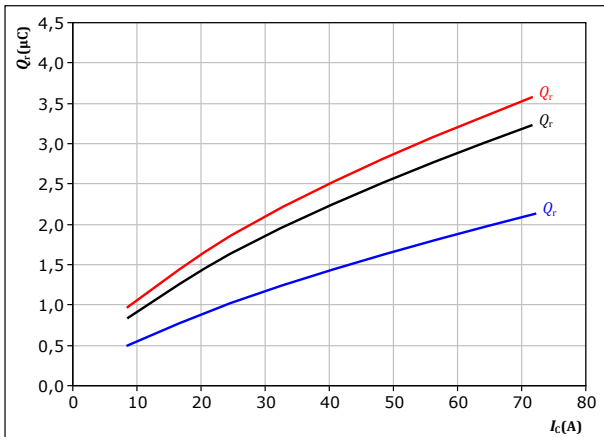


## Buck Switching Characteristics

figure 24. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

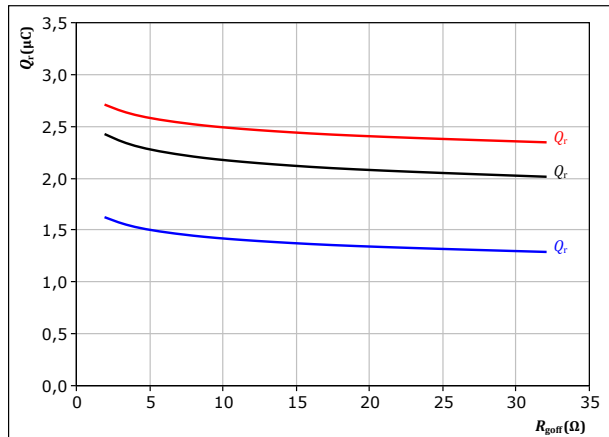
$V_{CE} = 350 \text{ V}$   
 $V_{GE} = -5/15 \text{ V}$   
 $R_{goff} = 8 \ \Omega$

$T_j$ : — 25 °C  
— 125 °C  
— 150 °C

figure 25. FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

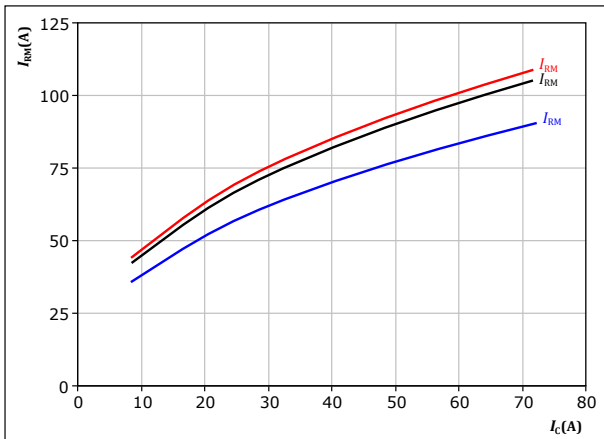
$V_{CE} = 350 \text{ V}$   
 $V_{GE} = -5/15 \text{ V}$   
 $I_c = 40 \text{ A}$

$T_j$ : — 25 °C  
— 125 °C  
— 150 °C

figure 26. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

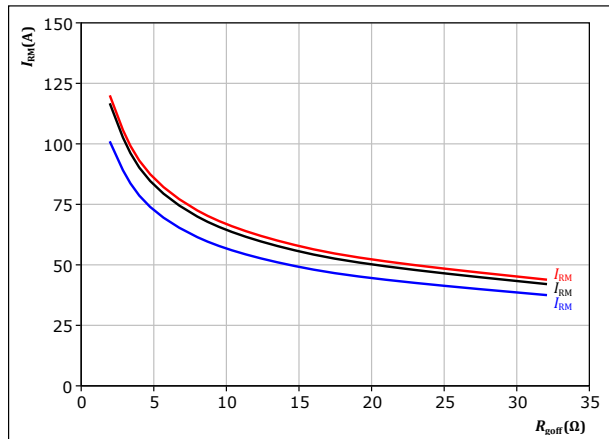
$V_{CE} = 350 \text{ V}$   
 $V_{GE} = -5/15 \text{ V}$   
 $R_{goff} = 8 \ \Omega$

$T_j$ : — 25 °C  
— 125 °C  
— 150 °C

figure 27. FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 350 \text{ V}$   
 $V_{GE} = -5/15 \text{ V}$   
 $I_c = 40 \text{ A}$

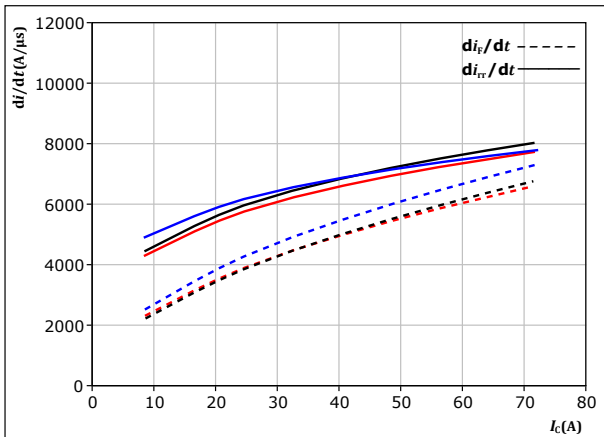
$T_j$ : — 25 °C  
— 125 °C  
— 150 °C



## Buck Switching Characteristics

**figure 28.** FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current  
 $di_f/dt, di_{rr}/dt = f(I_C)$

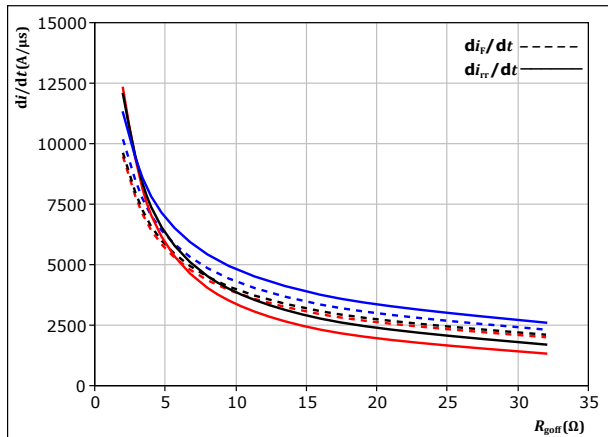


With an inductive load at

$V_{CE} =$	350	V	$T_j =$	25 °C
$V_{GE} =$	-5/15	V		125 °C
$R_{goff} =$	8	Ω		150 °C

**figure 29.** FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor  
 $di_f/dt, di_{rr}/dt = f(R_{goff})$

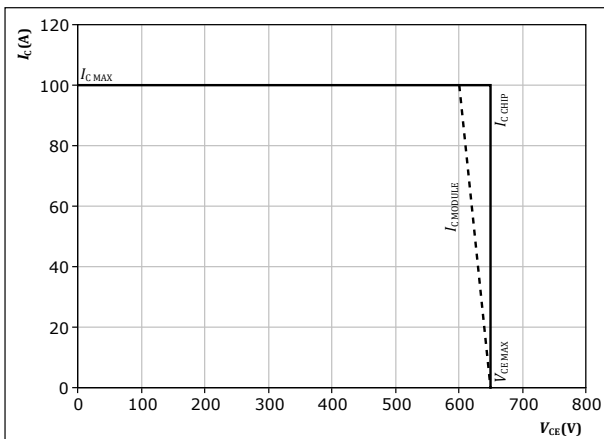


With an inductive load at

$V_{CE} =$	350	V	$T_j =$	25 °C
$V_{GE} =$	-5/15	V		125 °C
$I_C =$	40	A		150 °C

**figure 30.** IGBT

Reverse bias safe operating area  
 $I_C = f(V_{CE})$



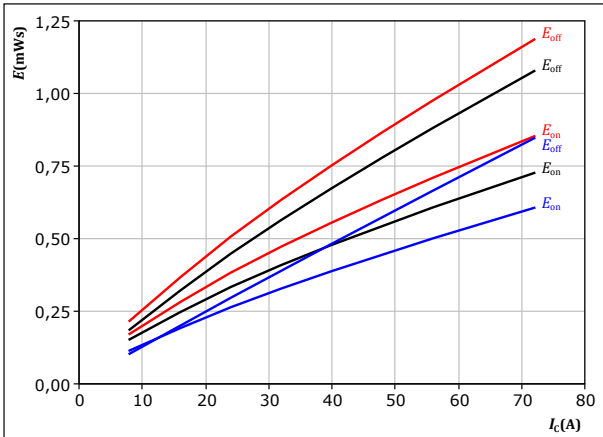
At  $T_j = 150$  °C  
 $R_{goff} = 8$  Ω  
 $R_{gson} = 8$  Ω



## Boost Switching Characteristics

**figure 31.** IGBT

Typical switching energy losses as a function of collector current  
 $E = f(I_c)$

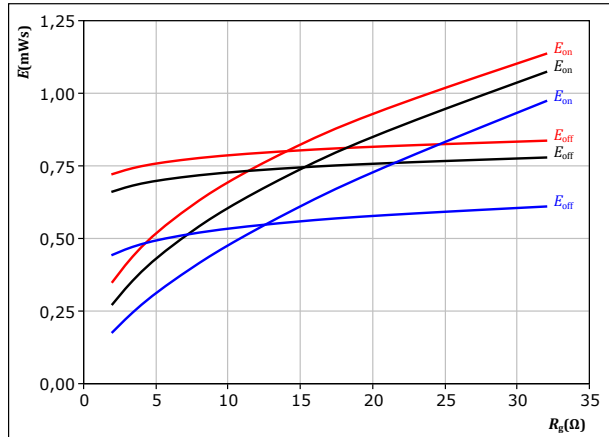


With an inductive load at

$V_{CE} = 350$ V	$T_j = 25$ °C
$V_{GE} = -5/15$ V	$T_j = 125$ °C
$R_{g(on)} = 8$ Ω	$T_j = 150$ °C
$R_{g(off)} = 8$ Ω	

**figure 32.** IGBT

Typical switching energy losses as a function of gate resistor  
 $E = f(R_g)$

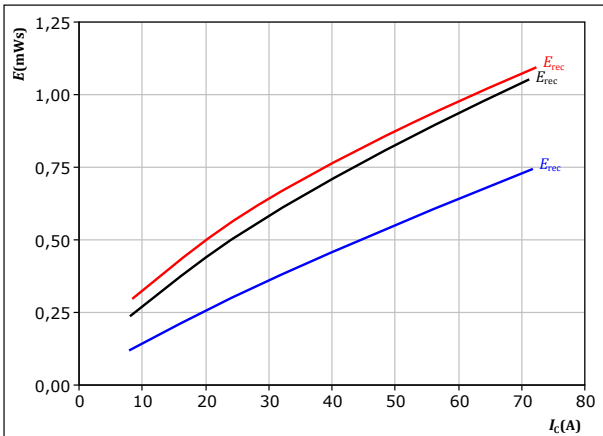


With an inductive load at

$V_{CE} = 350$ V	$T_j = 25$ °C
$V_{GE} = -5/15$ V	$T_j = 125$ °C
$I_c = 40$ A	$T_j = 150$ °C

**figure 33.** FWD

Typical reverse recovered energy loss as a function of collector current  
 $E_{rec} = f(I_c)$

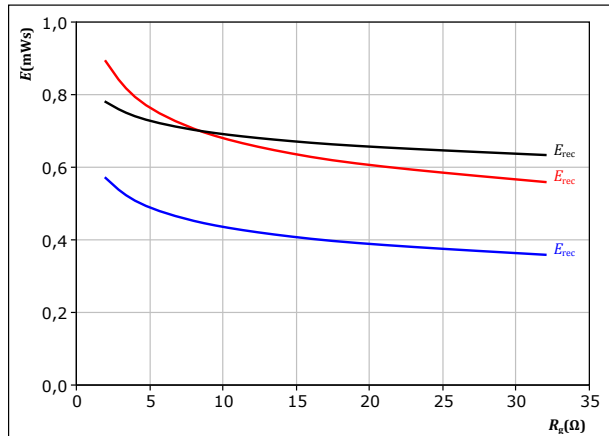


With an inductive load at

$V_{CE} = 350$ V	$T_j = 25$ °C
$V_{GE} = -5/15$ V	$T_j = 125$ °C
$R_{g(on)} = 8$ Ω	$T_j = 150$ °C

**figure 34.** FWD

Typical reverse recovered energy loss as a function of gate resistor  
 $E_{rec} = f(R_g)$



With an inductive load at

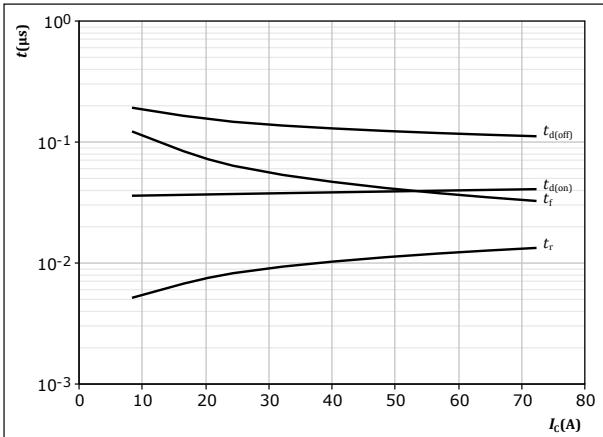
$V_{CE} = 350$ V	$T_j = 25$ °C
$V_{GE} = -5/15$ V	$T_j = 125$ °C
$I_c = 40$ A	$T_j = 150$ °C



## Boost Switching Characteristics

**figure 35.** IGBT

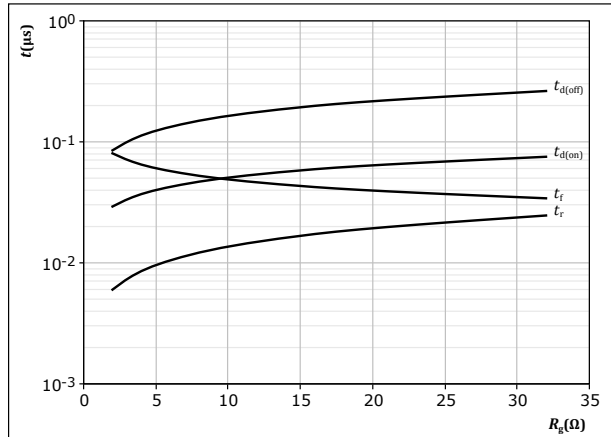
Typical switching times as a function of collector current  
 $t = f(I_c)$



With an inductive load at  
 $T_j = 150$  °C  
 $V_{CE} = 350$  V  
 $V_{GE} = -5/15$  V  
 $R_{gon} = 8$  Ω  
 $R_{goff} = 8$  Ω

**figure 36.** IGBT

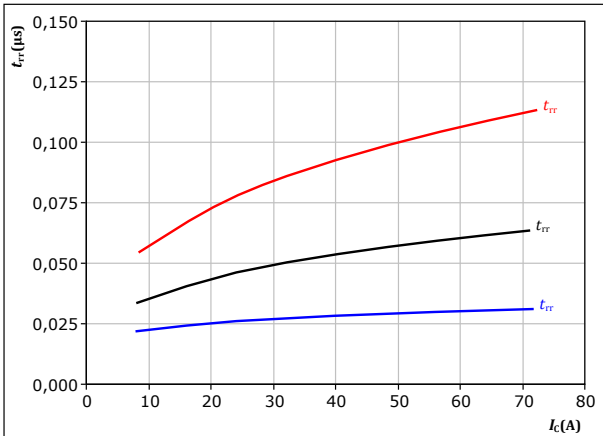
Typical switching times as a function of gate resistor  
 $t = f(R_g)$



With an inductive load at  
 $T_j = 150$  °C  
 $V_{CE} = 350$  V  
 $V_{GE} = -5/15$  V  
 $I_c = 40$  A

**figure 37.** FWD

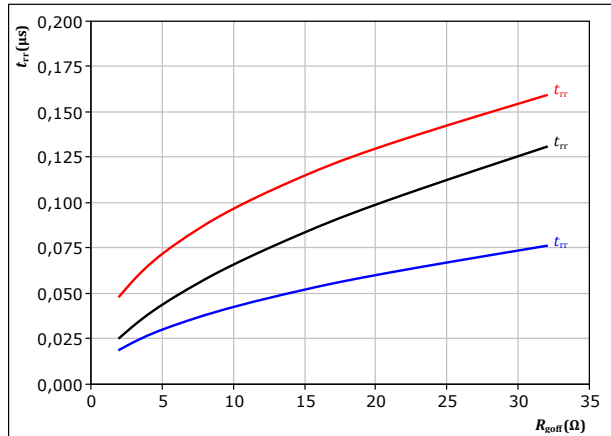
Typical reverse recovery time as a function of collector current  
 $t_{rr} = f(I_c)$



With an inductive load at  
 $V_{CE} = 350$  V  
 $V_{GE} = -5/15$  V  
 $R_{gon} = 8$  Ω  
 $T_j$ : — 25 °C  
— 125 °C  
— 150 °C

**figure 38.** FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor  
 $t_{rr} = f(R_{goff})$



With an inductive load at  
 $V_{CE} = 350$  V  
 $V_{GE} = -5/15$  V  
 $I_c = 40$  A  
 $T_j$ : — 25 °C  
— 125 °C  
— 150 °C

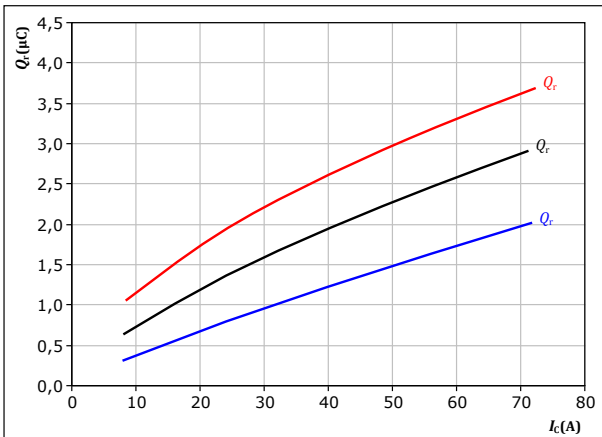


## Boost Switching Characteristics

figure 39. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

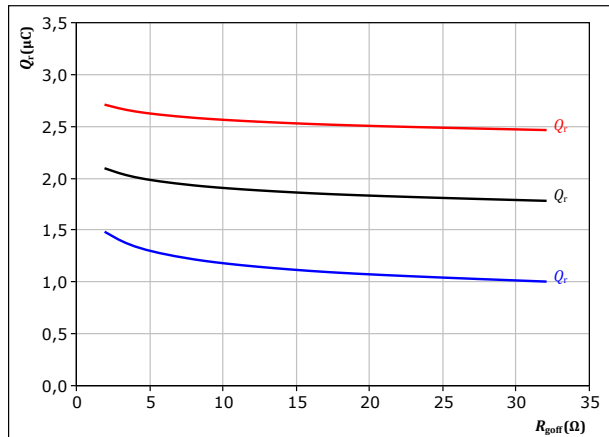
$V_{CE} = 350 \text{ V}$   
 $V_{GE} = -5/15 \text{ V}$   
 $R_{goff} = 8 \text{ } \Omega$

$T_j$ :  $25 \text{ } ^\circ\text{C}$  (blue)  
 $125 \text{ } ^\circ\text{C}$  (black)  
 $150 \text{ } ^\circ\text{C}$  (red)

figure 40. FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

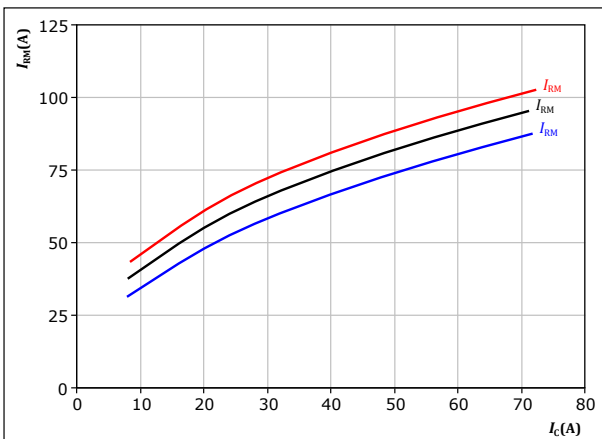
$V_{CE} = 350 \text{ V}$   
 $V_{GE} = -5/15 \text{ V}$   
 $I_c = 40 \text{ A}$

$T_j$ :  $25 \text{ } ^\circ\text{C}$  (blue)  
 $125 \text{ } ^\circ\text{C}$  (black)  
 $150 \text{ } ^\circ\text{C}$  (red)

figure 41. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

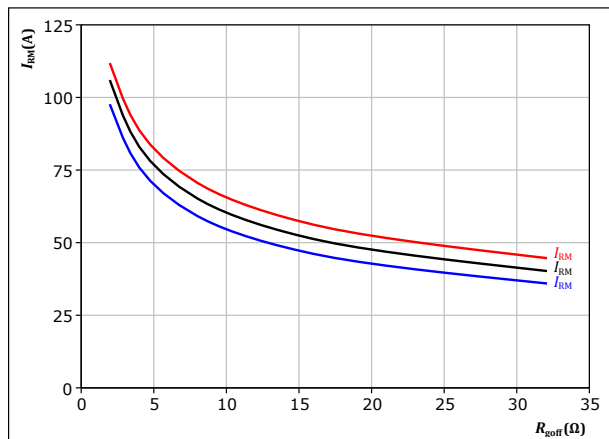
$V_{CE} = 350 \text{ V}$   
 $V_{GE} = -5/15 \text{ V}$   
 $R_{goff} = 8 \text{ } \Omega$

$T_j$ :  $25 \text{ } ^\circ\text{C}$  (blue)  
 $125 \text{ } ^\circ\text{C}$  (black)  
 $150 \text{ } ^\circ\text{C}$  (red)

figure 42. FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 350 \text{ V}$   
 $V_{GE} = -5/15 \text{ V}$   
 $I_c = 40 \text{ A}$

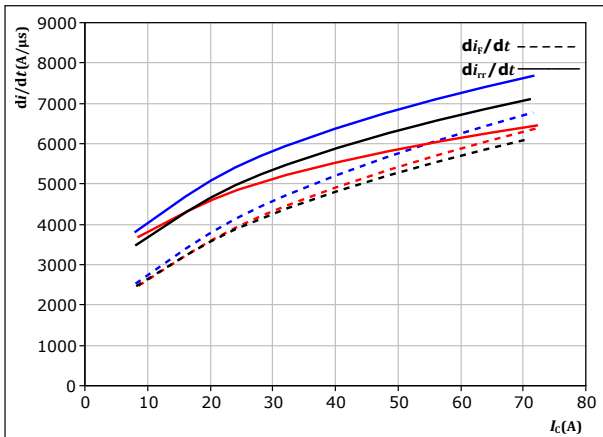
$T_j$ :  $25 \text{ } ^\circ\text{C}$  (blue)  
 $125 \text{ } ^\circ\text{C}$  (black)  
 $150 \text{ } ^\circ\text{C}$  (red)



## Boost Switching Characteristics

figure 43. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current  
 $di_f/dt, di_{rr}/dt = f(I_C)$



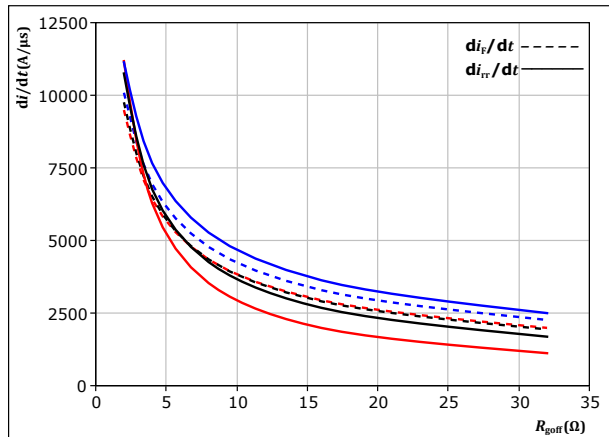
With an inductive load at

$V_{CE} = 350$  V  
 $V_{GE} = -5/15$  V  
 $R_{goff} = 8$  Ω

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 44. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor  
 $di_f/dt, di_{rr}/dt = f(R_{goff})$



With an inductive load at

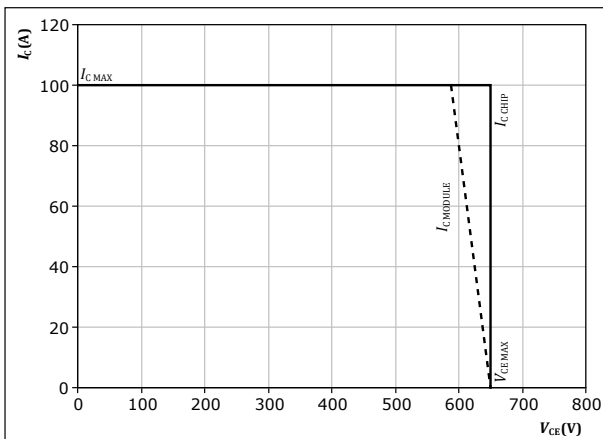
$V_{CE} = 350$  V  
 $V_{GE} = -5/15$  V  
 $I_C = 40$  A

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 45. IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$



At  $T_j = 150$  °C  
 $R_{goff} = 8$  Ω  
 $R_{goff} = 8$  Ω



## Switching Definitions

figure 46. IGBT

Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$  ( $t_{Eoff}$  = integrating time for  $E_{off}$ )

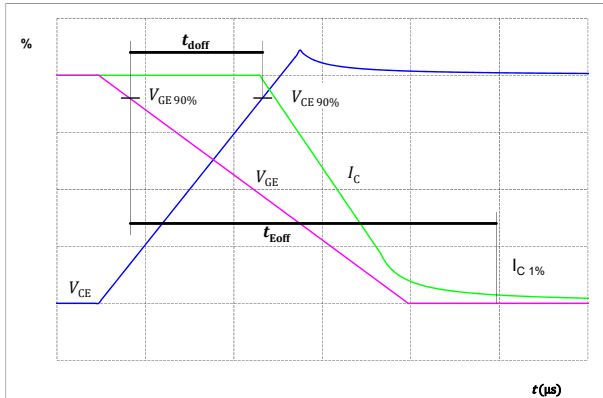


figure 47. IGBT

Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )

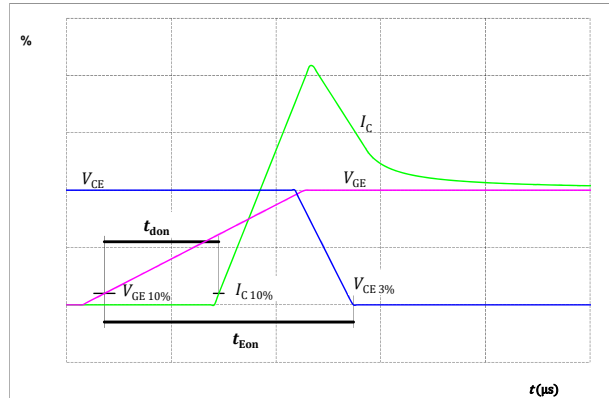


figure 48. IGBT

Turn-off Switching Waveforms & definition of  $t_f$

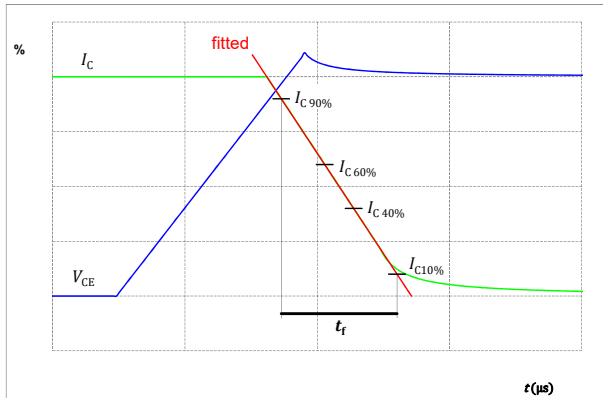
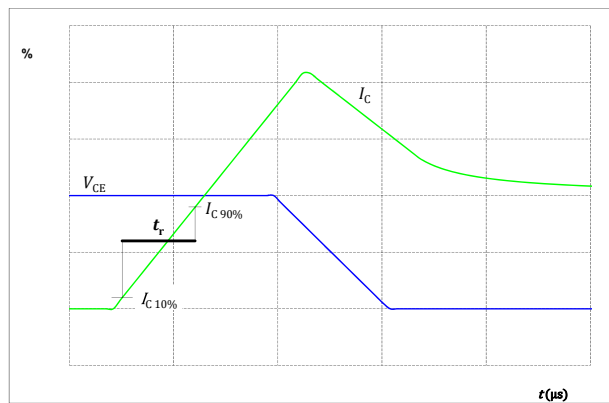


figure 49. IGBT

Turn-on Switching Waveforms & definition of  $t_r$







### Switching Definitions

figure 50. FWD

Turn-off Switching Waveforms & definition of  $t_{rr}$

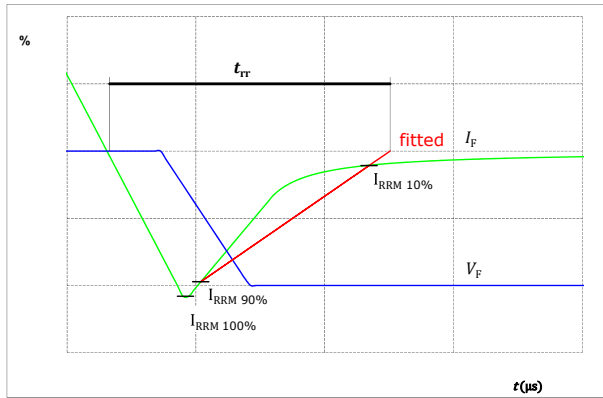
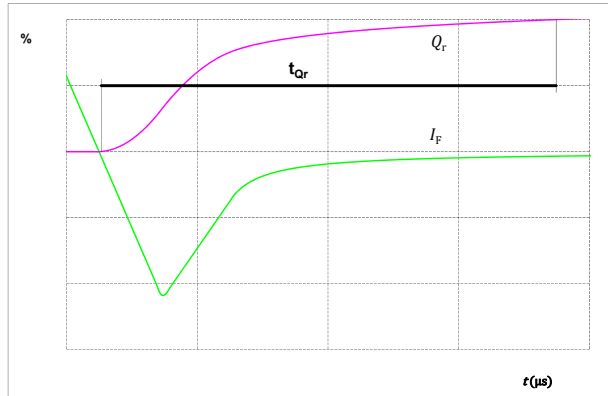


figure 51. FWD

Turn-on Switching Waveforms & definition of  $t_{Qr}$  ( $t_{Qr}$  = integrating time for  $Q_r$ )




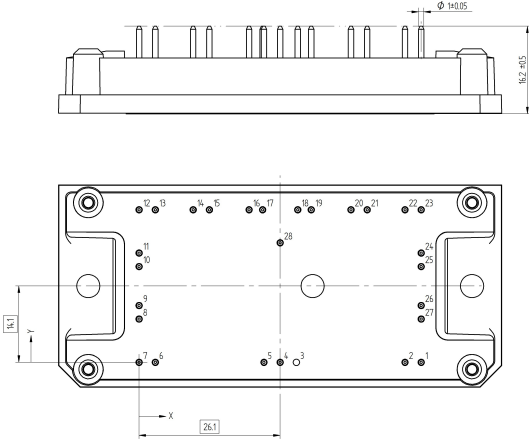


Vincotech

**10-FY07HVA050RG-L984F88**  
datasheet

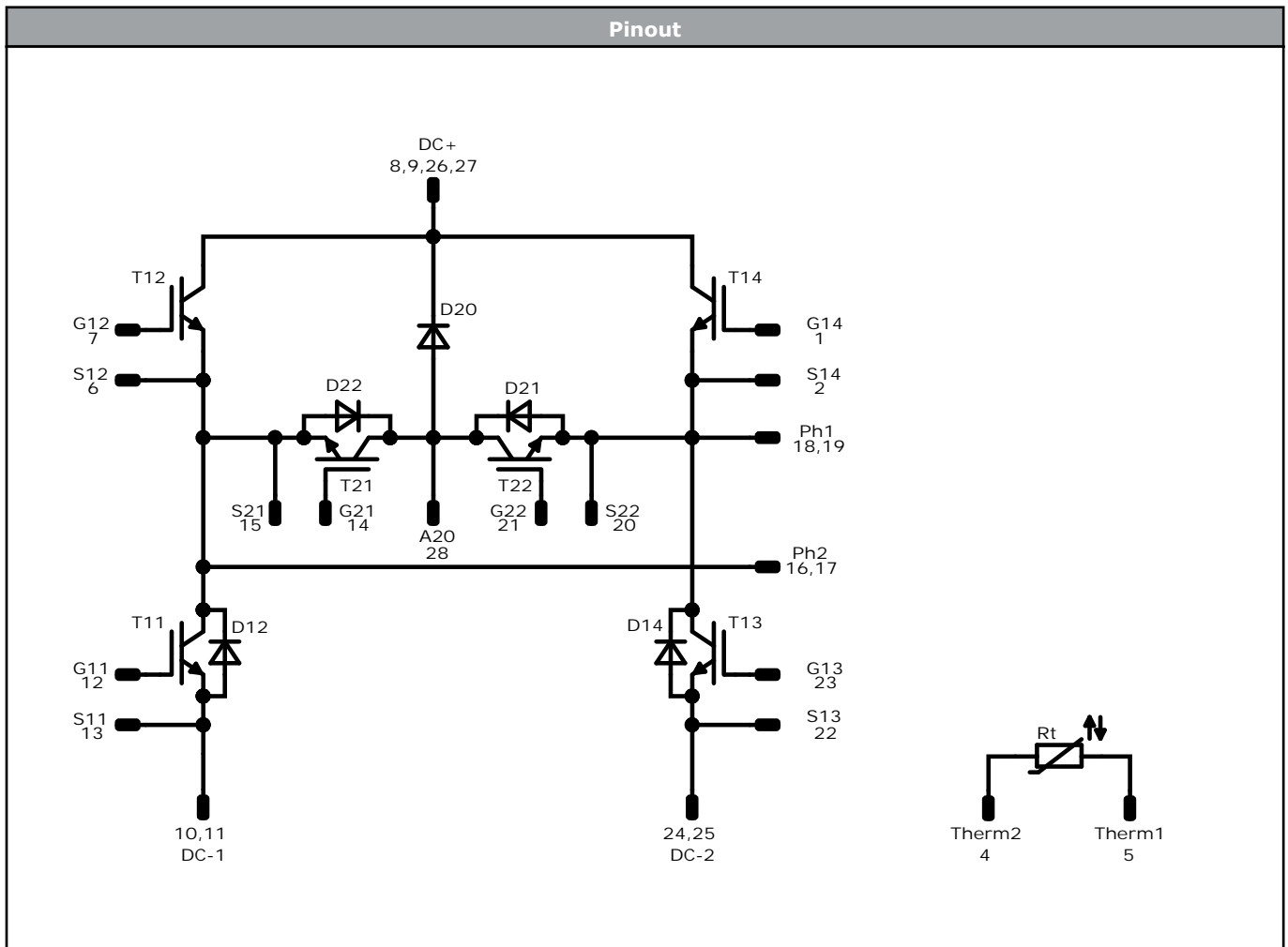
Ordering Code	
Version	Ordering Code
Without thermal paste	10-FY07HVA050RG-L984F88
With thermal paste (4,4 W/mK, PTM6000)	10-FY07HVA050RG-L984F88-/7/
With thermal paste (3,4 W/mK, PSX-P7)	10-FY07HVA050RG-L984F88-/3/

Marking						
Text	Name		Date code	UL & VIN	Lot	Serial
		NN-NNNNNNNNNNNNNN- TTTTIVV		WWYY	UL VIN	LLLLL
Datamatrix	Type&Ver	Lot number	Serial	Date code		
	TTTTTIVV	LLLLL	SSSS	WWYY		

Pin table [mm]				Function	
Pin	X	Y			
1	52,2	0		G14	<p>Tolerance of pinpositions: <math>\pm 0.5\text{mm}</math> of the end of pins Dimension of coordinate axis is only ordinal without tolerance</p>
2	49,2	0		S14	
3	not assembled				
4	26,1	0		Therm2	
5	23,1	0		Therm1	
6	3	0		S12	
7	0	0		G12	
8	0	8		DC+	
9	0	10,5		DC+	
10	0	17,7		DC-1	
11	0	20,2		DC-1	
12	0	28,2		G11	
13	3	28,2		S11	
14	10	28,2		G21	
15	13	28,2		S21	
16	20,35	28,2		Ph2	
17	22,85	28,2		Ph2	
18	29,35	28,2		Ph1	
19	31,85	28,2		Ph1	
20	39,2	28,2		S22	
21	42,2	28,2		G22	
22	49,2	28,2		S13	
23	52,2	28,2		G13	
24	52,2	20,2		DC-2	
25	52,2	17,7		DC-2	
26	52,2	10,5		DC+	
27	52,2	8		DC+	
28	26,1	22,1		A20	



Vincotech



Identification					
ID	Component	Voltage	Current	Function	Comment
T11, T13, T12, T14	IGBT	650 V	50 A	Buck Switch	
D21, D22	FWD	650 V	30 A	Buck Diode	
T21, T22	IGBT	650 V	50 A	Boost Switch	
D12, D14, D20	FWD	650 V	30 A	Boost Diode	
Rt	NTC			Thermistor	




Packaging instruction				
Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for <i>flow 1</i> packages see vincotech.com website.

Package data
Package data for <i>flow 1</i> packages see vincotech.com website.

Vincotech thermistor reference
See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
10-FY07HVA050RG-L984F88-D4-14	1 Jun. 2021	Merging Low- and High-side component IDs and Functions Update of Ordering Codes	

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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